

IntroducingSolderless LED Socket, Type CM

Tyco Electronics' Solderless LED Socket, Type CM provides a solderless quick termination to the 1500 lumen output Cree XLamp® MP-L™ LED. This solderless termination technique facilitates easy integration of the LED into the end customer's lighting fixtures with simple screw-down installation. Multiple versions are offered to provide application flexibility. To further enhance functionality to the fixture manufacturer, the socket also features integral, robust, snap attachment of LEDIL Tyra series reflector optics.

KEY FEATURES

- Solderless termination to the Cree XLamp MP-L LED
- Fast, rapid termination and assembly
 eliminates hand soldering wires to
 the MPL 0.70mm x 0.85mm pads
- Offered in separable board termination and wire termination versions
- Snap-on optics assembly using LEDIL's Tyra series reflector optics

APPLICATIONS

- Commercial and residential Lighting Fixtures
- Integrated custom lighting



Solderless LED Socket, Type CM



LIGHTING **APPLICATIONS**





Channel/Sign





Digital Signage

Architectural





Street & Stadium

Indoor





Office

ELECTRICAL

Operating current: 500mA Operating voltage: 30VDC

Dielectric withstanding voltage: 500 VDC

MECHANICAL

Select silver plated contact interface to Cree XLamp MP-L LED

6 line termination in both wire and board termination versions

Secure attachment to substrate using three standard #4 or M3 screws

Wire version incorporates 6 position AMP Mini CT header

Low profile- <3 mm height around the dome (w/o latches) and 5.20 mm high at the connector interface

MATERIALS

Housings: 94 VO rated high temperature resistant thermoplastic

- Base material copper alloy
- Silver plated interface to Cree XLamp MP-L LED
- Tin plated interface to AMP Mini CT or to PCB

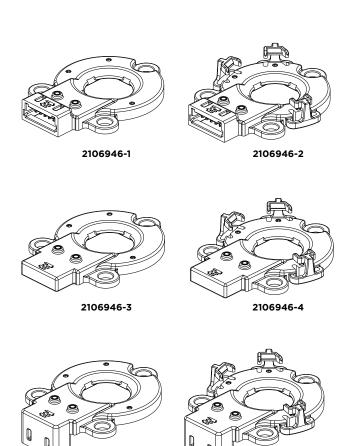
APPLICATIONS AND SPECIFICATION

Product Specification 108-2439

Application specification 114-13281

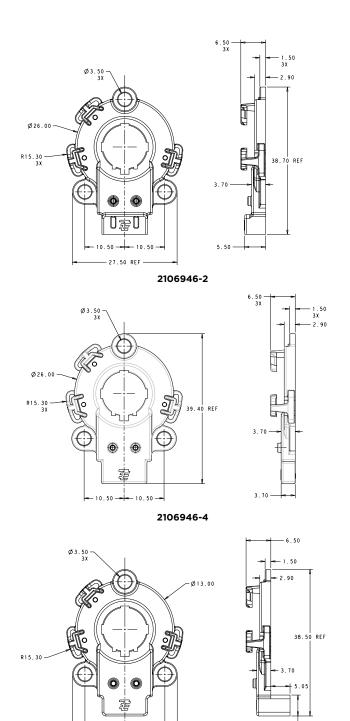
PRODUCT OFFERINGS

PART NUMBER	DESCRIPTION
2106946-1	LED to Wire, w/o Optics Latch
2106946-2	LED to Wire, w/ Optics Latch
2106946-3	LED to Board, w/o Optics Latch
2106946-4	LED to Board, w/ Optics Latch
2106946-5	LED to Inverted Wire, w/o Optics Latch
2106946-6	LED to Inverted Wire, w/ Optics Latch
2058943-5	AMP Mini CT, 6 position Cable Assembly



2106946-6

2106946-5



- 27.50 REF

2106946-6

Questions to ask at design in

Is the customer looking at or is the customer using the Cree XLamp MP-L LED? If yes, what is the application and how is the customer terminating to the pads on the top of the Cree XLamp MP-L LED?

The Solderless LED Socket Type CM offers a solderless termination to the pads on the top of the socket and offers an ideal alternative to hand soldering wires onto very small pads spaced on 1.25 mm centerlines.

How do I decide which socket to use?

This is entirely dependent on the customers application. In such instances where the Cree XLamp MP-L LED is mounted to a circuit board, it often makes sense for the customer to also mount driver circuitry onto the same circuit board. The board mount socket can then be used to connect the Cree XLamp MP-L LED to the PCB and thereby to the driver circuitry on the board. Another remote connector (AMP Mini CT, micro MATE-N-LOK, HPI connectors or the like) is then used to provide power to the board.

The Cree XLamp MP-L LED can also be thermally epoxied directly to a heat sink. If this is the avenue the customer is using, then one of the wire mount versions is best. The inverted wire version can be used where the customer has the option to allow for connector access within the heat sink and offers the most compact installation option. In instances where the customer has room or can not provide connector access within the heat sink, the horizontal wire mount is used since it allows easy access to the connection from the LED side of the assembly.

The Cree XLamp MP-L LED employs three parallel strings of LEDs and therefore requires three circuits hence the need for 6 connections. Each LED circuit is nominally 25VDC at 150mA which is well within the 50VDC voltage rating of the AMP Mini CT connector. Can the customer serially connect the three strings at 75VDC rather than run them in parallel?

This is not recommended since the resulting 75VDC drop across the LED exceeds the 50VDC rating of the AMP Mini CT connector.

Is special application tooling required?

Not typically although when thermally epoxying the Cree XLamp MP-L LED directly to the heat sink, a fixture is recommended to ensure the LED is properly located to the socket mounting holes in the heat sink

Do I need to epoxy the Cree XLamp MP-L LED to the heat sink or can I just use thermal grease or solid thermal pad as the interface material?

TE does not recommend thermal grease or thermal pads with the SolderlessLED Socket, Type CM as the socket is not designed to provide the normal force to the grease/pad required for optimal thermal performance.

FOR MORE INFORMATION: www.tycoelectronics.com/lighting

Technical Support

Internet: www.tycoelectronics.com/help

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Part numbers in this brochure are RoHS Compliant*, unless marked otherwise.

*as defined www.tycoelectronics.com/leadfree

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